

MMSZ4684

General Description

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

Features

- · Compact surface mount with same footprint as mini-melf
- 500mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16kV) per Human Body Model

Ordering

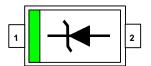
• 7 inch reel (178mm); 8mm Tape; 3,000 units per reel.

Absolute Maximum Ratings (note 1) T_A=25°C unless otherwise noted

Symbol	Parameter	Value	Units
T _{STG}	Storage Temperature	-55 ~ 150	°C
TJ	Maximum Junction Temperature	-55 ~ 150	°C
P_D	Total Power Dissipation at 25°C Derate above 25°C	500 6.7	mW mW/°C
R_{QJA}	Thermal Resistance Junction to Ambient	340	°C/W
R _{QJA} R _{QJL}	Thermal Resistance Junction to Lead	150	°C/W
ΔV_Z	Maximum Voltage Change (note 2)	950	mV
Lead Solder Temperature (Max 10 second duration)		260	°C
Nominal Zener Voltage (V _Z) at 50μA		3.3	V

Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. Note 2: Voltage change is equal to the difference between V_Z at $100\mu A$ and V_Z at $10\mu A$.

Top Mark: CK 1: Cathode 2: Anode

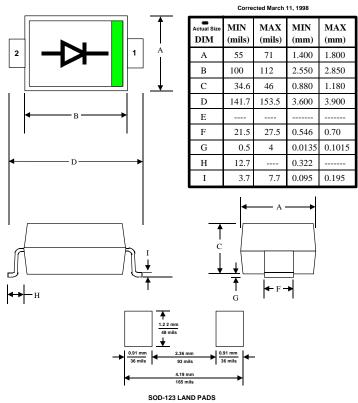


Electrical Characteristics T_A=25°C unless otherwise noted

Symbol	Characteristics	Test Conditions	Min.	Max.	Units
V_Z	Zener Voltage	$I_{ZT} = 50\mu A_{D.C}$	3.14	3.47	V
I _R	Reverse Leakage	V _R = 1.5V		7.5	μΑ
V _F	Forward Voltage	I _F = 10mA		900	mV
ΔV_Z	Delta Zener Voltage (Note 2)	I _{ZT} = 100μA to 10μA		950	mV

©2003 Fairchild Semiconductor Corporation MMSZ4692, Rev. A

SOD-123 PACKAGE PACKAGE CODE = (D6) Fairchild Semiconductor's Criteria



©2003 Fairchild Semiconductor Corporation MMSZ4692, Rev. A

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

FACT Quiet Series™ LittleFET™ ACEx™ Power247™ SuperSOT™-6 MICROCOUPLER™ PowerTrench® ActiveArray™ SuperSOT™-8 FAST® Bottomless™ MicroFET™ **OFET®** SvncFET™ FASTr™ CoolFET™ QSTM TinyLogic[®] $\mathsf{FRFET}^\mathsf{TM}$ MicroPak™ CROSSVOLT™ MICROWIRE™ QT Optoelectronics™ TINYOPTO™ GlobalOptoisolator™ TruTranslation™ DOME™ GTO™ Quiet Series™ MSX™ UHC™ EcoSPARK™ RapidConfigure™ HiSeC™ MSXPro™ UltraFET® E²CMOSTM I2CTM OCX^{TM} RapidConnect™ EnSigna™ SILENT SWITCHER® VCX^{TM} ImpliedDisconnect[™] OCXPro[™] FACT™ OPTOLOGIC® SMART START™ ISOPLANAR™ SPM™ Across the board. Around the world. $^{\text{TM}}$ OPTOPLANAR $^{\text{TM}}$

Stealth™ PACMAN™ The Power Franchise™ РОР™ SuperSOT™-3 Programmable Active Droop™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS. NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I5

ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative